

Technical Product Information

ELSOLD Al-P Paste Flux

Highest activity for soldering of Aluminum alloys by solder forming effect

Minimized melting temperature for a wider field of possible soldering and increased efficiency

Simple application

Innovative technology

Al-P

ELSOLD Al-P offers best solutions for soldering Aluminum alloys, which need a very high activity, in different soldering processes.

Classification

INH1

Application and soldering process

Application of paste by manual or automatic dispensing.

Application of solder alloy (tin based; best: SN100(Ag) MA-S) as wire, preform or foil.

Heating by furnace, hot air, flame or iron to >235 °C.

Cleaning

With water based cleaning agents.

Packaging

10 cc syringes for manual or automatic dispensing.

Shelf Life

We guarantee a minimum shelf life of 12 months if the material is properly stored in a clean environment.

Safety

Consider SDS. Wear personal protective equipment and use exhaustion.

The information contained herein is based on technical data that we believe to be reliable and is intended for use by persons having technical skill at their own risk. Users of our products should make their own tests to determine the suitability of each product for their particular process. TAMURA ELSOLD will assume no liability for results obtained or damages incurred through the application of the data presented.